



05-10-2007



103404186

FORM PTO-1595
(Rev. 08/05)DEPARTMENT OF COMMERCE
Patent and Trademark Office

Docket No.: 069576-0212

PATENT APPLICATION

To the Director of the U. S. Patent and Trademark Office: Please record the attached documents or the new address(es) below.

1. Name of Conveying Party(ies)

Young Ki LEE, Seog Moon CHOI, Sang Hyun SHIN

Additional name(s) of conveying party(ies) attached? ☐ Yes ☐ No

3. Nature of Conveyance/Execution Date(s)

Execution Date(s): February 21, 2007, February 21, 2007,

February 22, 2007 (respectively)

- ☒ Corrected Assignment ☐ Merger
☐ Security Agreement ☐ Change of Name
☐ Joint Research Agreement
☐ Government Interest Assignment
☐ Executive Order 9424, Confirmatory License
☐ Other

2. Name and address of receiving party(ies)

Name: SAMSUNG ELECTRO-MECHANICS CO., LTD.

Address: 314, Maetan3-Dong, Yeongtong-Gu, Suwon,
Gyeonggi-Do, REPUBLIC OF KOREAAdditional name(s) & address(es) attached? ☐ Yes ☐ No

4. Application or patent number(s):

A. Patent Application No(s).

☐ This document is being filed together with a new application.

B. Patent No(s).

Additional numbers attached? ☐ Yes ☐ No

5. Name and address to whom correspondence concerning document should be mailed:

Name: MCDERMOTT WILL & EMERY LLP

Internal Address:

Street Address: 600 13th Street, N.W.

City: Washington State: D. C. Zip: 20005-3096

Phone Number: 202.756.8000

Fax Number: 202.756.8087

Email Address:

6. Total number of applications and patents involved: 1

7. Total fee (37 CFR 1.21(h) & 3.41) \$40.00

- ☐ Authorized to be charged by credit card
☒ Fees previously paid
☐ Enclosed
☐ None required (government interest not affecting title)nt

8. Payment Information:

a. Credit Card Last 4 Numbers _____

Expiration Date _____

b. Deposit Account Number 500417

Authorized User Name _____

9. Signature.

Stephen A. Becker, 26,527

May 7, 2007

Name and Registration No. of Person Signing

Signature

Date

Total number of pages including cover sheet, attachments and documents: 5

OMB No. 0651-0027 (exp. 6/30/2008)

U.S. PTO
11/723236
03/19/2007

03-30-2007

FORM PTO-1595
(Rev. 08/05)



BET

U.S. DEPARTMENT OF COMMERCE
Patent and Trademark Office

Docket No.: 069576-0212

103389355

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- ☐ Authorized to be charged by credit card
☒ Authorized to be charged to deposit account
☐ Enclosed
☐ None required (government interest not affecting title)nt

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b. Deposit Account Number 500417
Authorized User Name _____

9. Signature.

Stephen A. Becker, 26,527

March 19, 2007

Name and Registration No. of Person Signing

Signature

Date

Total number of pages including cover sheet, attachments and documents: 2

OMB No. 0651-0027 (exp. 6/30/2008)

PATENT
REEL: 019289 FRAME: 0641

ASSIGNMENT

In consideration of the premises and other good and valuable consideration in hand paid, the receipt and sufficiency of which is hereby acknowledged, the undersigned,

(1) <u>LEE, Young Ki</u>	(5) _____
(2) <u>CHOI, Seog Moon</u>	(6) _____
(3) <u>SHIN, Sang Hyun</u>	(7) _____
(4) _____	(8) _____

who have made a certain new and useful invention, hereby sell, assign and transfer unto
SAMSUNG ELECTRO-MECHANICS CO., LTD.
314, Maetan3-Dong, Yeongtong-Gu, Suwon, Gyunggi-do, Republic of Korea

its successors and assigns (hereinafter designated "ASSIGNEE") the entire right, title and interest for the United States of America as defined in 35 U.S.C. 100 in the invention entitled

INSULATION STRUCTURE FOR HIGH TEMPERATURE CONDITIONS AND
MANUFACTURING METHOD THEREOF

(a) for which an application for United States Letters Patent was filed on _____,
and identified by United States Serial No. _____; or

(b) for which an application for United States Letters Patent was executed on _____


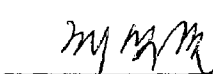

and the undersigned hereby authorize and request the United States Commissioner of Patents and Trademarks to issue any and all United States Letters Patent which may be granted therefor and any and all extensions, divisions, reissues, substitutes, renewals, continuations, or continuations-in-part thereof, and the right to all benefits under the International Convention for the Protection of Industrial Property to the said ASSIGNEE, for its interest as ASSIGNEE, its successors, assigns and legal representatives; the undersigned agree that the attorneys of record in said application shall hereafter act on behalf of said ASSIGNEE;

AND the undersigned hereby agree to transfer a like interest, and to render all necessary assistance in making application for and obtaining original, divisional, reissued or extended Letters Patent of the United States, upon request of the said ASSIGNEE, its successors, assigns and legal representatives, and without further remuneration, in and to any improvements, and applications for patent based thereon, growing out of or related to the said invention; and to execute any papers by the said ASSIGNEE, its successors, assigns and legal representatives, deemed essential to ASSIGNEE's full protection and title in and to the invention hereby transferred.

SIGNED on the dates indicated aside our signatures:

INVENTORS

DATE SIGNED

1) 	<u>2007. 2. 21</u>
Name: LEE, Young Ki	
2) 	<u>2007. 2. 21</u>
Name: CHOI, Seog Moon	
3) 	<u>2007. 2. 22</u>
Name: SHIN, Sang Hyun	
4) _____	_____
Name: _____	
5) _____	_____
Name: _____	

PATENT